

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Peng-Fu Hsu</td><td>09/18/2006</td></tr><tr><td>Fong-Yu Yen</td><td>09/18/2006</td></tr><tr><td>Yi-Shien Mor</td><td>09/18/2006</td></tr><tr><td>Huan-Just Lin</td><td>09/18/2006</td></tr><tr><td>Ying Jin</td><td>09/28/2006</td></tr><tr><td>Hun-Jan Tao</td><td>09/18/2006</td></tr></tbody></table>	Name	Execution Date	Peng-Fu Hsu	09/18/2006	Fong-Yu Yen	09/18/2006	Yi-Shien Mor	09/18/2006	Huan-Just Lin	09/18/2006	Ying Jin	09/28/2006	Hun-Jan Tao	09/18/2006	
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RECEIVING PARTY DATA															
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO. LTD.														
Street Address:	No. 8, Li-Hsin Rd. 6														
Internal Address:	Science-Based Industrial Park														
City:	Hsin-Chu														
State/Country:	TAIWAN														
Postal Code:	300-77, R.O.C.														
PROPERTY NUMBERS Total: 1															
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11552704</td></tr></tbody></table>	Property Type	Number	Application Number:	11552704											
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Application Number:	11552704														
CORRESPONDENCE DATA															
Fax Number:	(770)951-0933														
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
Phone:	7709339500														
Email:	dan.mcclure@tkhr.com														
Correspondent Name:	Daniel R. McClure														
Address Line 1:	100 Galleria Parkway														
Address Line 2:	Suite 1750														
Address Line 4:	Atlanta, GEORGIA 30339														
ATTORNEY DOCKET NUMBER:	252011-4100														

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PATENT

500169536

REEL: 018434 FRAME: 0583

NAME OF SUBMITTER:

Daniel R. McClure

Total Attachments: 3

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**PATENT**

**REEL: 018434 FRAME: 0584**

## ASSIGNMENT

WHEREAS, Peng-Fu HSU, Fong-Yu YEN, Yi-Shien MOR, Huan-Just LIN, Ying JIN and Hun-Jan TAO hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SEMICONDUCTOR DEVICES WITH DUAL-METAL GATE STRUCTURES AND FABRICATION METHODS THEREOF

Filed: \_\_\_\_\_ Serial No. \_\_\_\_\_

Executed on: September 18, 2006 and September 28, 2006

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd. of No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Peng-Fu Hsu  
Peng-Fu HSU

2006/9/18.  
Date:

Fong-Yu Yen  
Fong-Yu YEN

2006/9/18  
Date:

Yi-Shien MOR  
Yi-Shien MOR

2006/9/18  
Date:

Huan-Just Lin  
Huan-Just LIN

2006/9/18  
Date:

Ying JIN  
Ying JIN

09/28/2006  
Date:

Han-Jan TAO  
Han-Jan TAO

2006/9/18  
Date: